

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT3658921

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
CHAN SEOB SHIN	11/26/2015
HYOUNG JIN LIM	11/26/2015
KYOUNG WAN KIM	11/26/2015
YEO JIN YOON	11/26/2015
JACOB J RICHARDSON	10/07/2015
DANIEL ESTRADA	10/02/2015
EVAN C. O'HARA	10/07/2015
HAORAN SHI	10/05/2015
RECEIVING PARTY DATA	
Name:	SEOUL SEMICONDUCTOR CO., LTD.
Street Address:	1B-25, 97-11, SANDAN-RO 163BEON-GIL
Internal Address:	DANWON-GU, GYEONGGI-DO
City:	ANSAN-SI
State/Country:	KOREA, REPUBLIC OF
Postal Code:	425-851
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14759603
CORRESPONDENCE DATA	
Fax Number:	(703)288-5139
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	703-288-5105
Email:	patent@park-law.com
Correspondent Name:	H.C. PARK & ASSOCIATES, PLC
Address Line 1:	1894 PRESTON WHITE DRIVE
Address Line 4:	RESTON, VIRGINIA 20191
ATTORNEY DOCKET NUMBER:	P6565US00
NAME OF SUBMITTER:	HAE-CHAN PARK

SIGNATURE:	/hae-chan park/
DATE SIGNED:	12/15/2015
	This document serves as an Oath/Declaration (37 CFR 1.63).
Total Attachments: 9 source=P6565US00-Assignment#page1.tif source=P6565US00-Assignment#page2.tif source=P6565US00-Assignment#page3.tif source=P6565US00-Assignment#page4.tif source=P6565US00-Assignment#page5.tif source=P6565US00-Assignment#page6.tif source=P6565US00-Assignment#page7.tif source=P6565US00-Assignment#page8.tif source=P6565US00-Assignment#page9.tif	



ASSIGNMENT SERVING AS DECLARATION PER 37 C.F.R. § 1.63(e)

As a below named inventor and Assignor, I declare that:

This assignment and declaration are directed to:

United States application no. 14/759,603 filed on July 7, 2015, which is the national stage entry of PCT/KR2013/008598, filed on September 25, 2013, and which claims priority from: Korean Patent Application No. 10-2013-0001877, filed January 8, 2013.

As amended on _____ (if applicable);

The above-identified Application was made or authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the Application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. § 1001 by fine or imprisonment of not more than five (5) years, or both.

Whereas, Assignor has invented certain new and useful processes, machines, articles of manufacture, compositions of matter, and/or improvements thereof ("Invention") disclosed in the Application,

Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to:

Seoul Semiconductor Co., Ltd.
1B-25, 97-11, Sandan-ro 163beon-gil
Danwon-gu, Ansan-si
425-851 Gyeonggi-do
Republic of Korea

Seoul Semiconductor Co., Ltd. herein further referred to as ("Assignee").

Now, for valuable consideration by Assignee to Assignor, the receipt of which is hereby acknowledged, and for other good and valuable consideration, Assignee and Assignor hereby agree as follows:

Assignor hereby conveys, assigns, sells and transfers to Assignee all rights, title and interests in and to the Invention disclosed in said application and in and to any Letters Patent of the United States (US), any continuation, division, renewal, or substitute thereof, and hereby grant to Assignee the right to apply in its own name for patents or Inventor's certificates and related rights heretofore or hereafter filed for the Invention in any and all countries, including (without limitation) all rights to claim priority based thereon, all patents granted thereon and all reissues, extensions and renewals thereof.



Assignor hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment.

Assignor further covenants that Assignee will, upon Assignee's request, be provided promptly with all pertinent facts and documents relating to the Invention, Patent, Application and any patents granted thereon, as may be known and accessible to Assignor, and Assignor will testify as to the same in any interference, litigation or proceeding related thereto and will promptly execute and deliver to Assignee or Assignee's legal representative any and all papers, instruments or affidavits required to apply for, protect, obtain, maintain, issue, defend and enforce the Application, Patent, Invention, whether in the US or any and all foreign countries and any patents granted thereon and/or for obtaining any reissue or reissues of any patent which may be granted for the invention and perform such further acts which may be necessary or desirable to carry out the intent of this agreement as the Assignee thereof shall hereafter require and prepare at assignee's expense.

IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

First Inventor's and Assignor's Name: Chan Seob SHIN

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
Danwon-gu, Ansan-si
Gyeonggi-do
Republic of Korea

First Inventor's and Assignor's Signature: _____

Date: _____

Second Inventor's and Assignor's Name: Hyoung Jin LIM

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Gyeonggi-do
Republic of Korea

Second Inventor's and Assignor's Signature: _____

Date: _____



Third Inventor's and Assignor's Name: Kyoung Wan KIM

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Republic of Korea

Third Inventor's and Assignor's Signature: _____

Date: _____

Fourth Inventor's and Assignor's Name: Yeon Jin YOON

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Fourth Inventor's and Assignor's Signature: _____

Date: _____

Fifth Inventor's and Assignor's Name: Jacob J RICHARDSON

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Fifth Inventor's and Assignor's Signature: 

Date: 10/7/2015



Sixth Inventor's and Assignor's Name: Daniel ESTRADA

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Sixth Inventor's and Assignor's Signature: _____

Date: _____

Seventh Inventor's and Assignor's Name: Evan C. O'HARA

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Seventh Inventor's and Assignor's Signature: 

Date: 10/7/2015

Eighth Inventor's and Assignor's Name: Haoran SHI

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Eighth Inventor's and Assignor's Signature: _____

Date: _____



Sixth Inventor's and Assignor's Name: Daniel ESTRADA

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Sixth Inventor's and Assignor's Signature: *Daniel Estrada*

Date: 10/02/15

Seventh Inventor's and Assignor's Name: Evan C. O'HARA

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Seventh Inventor's and Assignor's
Signature: _____

Date: _____

Eighth Inventor's and Assignor's Name: Haoran SHI

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
Danwon-gu, Ansan-si
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Republic of Korea

Eighth Inventor's and Assignor's
Signature: _____

Date: _____



Sixth Inventor's and Assignor's Signature: _____

Date: _____

Seventh Inventor's and Assignor's Name: Evan C. O'HARA

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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Seventh Inventor's and Assignor's Signature: _____

Date: _____

Eighth Inventor's and Assignor's Name: Haoran SHI

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
Danwon-gu, Ansan-si
Gyeonggi-do
Republic of Korea

Eighth Inventor's and Assignor's Signature:  _____

Date: 10-05-15



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Whereas, Assignor desires to convey all rights, titles, and interests in and to the same to:

Seoul Semiconductor Co., Ltd.
1B-25, 97-11, Sandan-ro 163beon-gil
Danwon-gu, Ansan-si
425-851 Gyeonggi-do
Republic of Korea

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IN WITNESS WHEREOF, Inventor and Assignor has hereunto set hand and seal.

First Inventor's and Assignor's Name: Chan Seob SHIN

Address: 1B-25, 97-11, Sandan-ro 163beon-gil
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First Inventor's and Assignor's Signature: Chan Seob Shin

Date: 11. 26. 2015

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Date: 11. 26. 2015



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Date: 2015. 11. 26.

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Fourth Inventor's and Assignor's Signature: 

Date: 2015. 11. 26.

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Republic of Korea

Fifth Inventor's and Assignor's Signature: _____

Date: _____